

## PATENT ASSIGNMENT

Electronic Version v08

Stylesheet Version v02

SUBMISSION TYPE:

NEW ASSIGNMENT

NATURE OF CONVEYANCE:

ASSIGNMENT OF ASSIGNOR'S INTEREST

## CONVEYING PARTY DATA

Name	Execution Date
Tsung-Wei Huang	2002-10-09
Chih-Ching Chen	2002-10-09

## RECEIVING PARTY DATA

Name	Street Address	Internal Address	City	State/Country	Postal Code
BenQ Corporation	No. 157, Shan-Ying Road, Gueishan		Tao-Yuan Hsien	TAIWAN	

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number	10708152

## CORRESPONDENCE DATA

FAX NUMBER: 8064986673

*Correspondence will be sent via US Mail when the fax attempt is unsuccessful.*

When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the official record on file at the USPTO.

CUSTOMER NUMBER: 027765

NAME OF PERSON SIGNING:

WINSTON HSU

DATE SIGNED:

2005-10-13

Total Attachments: 2

source=ACMP0021-1-A3ASS1.tif

source=ACMP0021-1-A3ASS2.tif

CH \$40.00 503105 10708152

PATENT

800021540

REEL: 016639 FRAME: 0978

**PATENT**

**ASSIGNMENT OF INVENTION**

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

**ASSIGNORS (Inventors):**

Name: Tsung-Wei Huang Nationality: R.O.C.  
Address: 5F, No.22, Ta-Pei Rd., Shih-Lin, Taipei City, Taiwan, R.O.C.

Name: Chih-Ching Chen Nationality: R.O.C.  
Address: 4F-5, No.145, Sec.2, Huan-Ho S. Rd., Taipei City, Taiwan, R.O.C.

Name: \_\_\_\_\_ Nationality: \_\_\_\_\_  
Address: \_\_\_\_\_ *W. I. Chen*  
*Reg. NO. 41526*

Name: \_\_\_\_\_ Nationality: \_\_\_\_\_  
Address: \_\_\_\_\_ *10/13/2005*

Hereby sells, assigns and transfers to BenQ **BENQ Corporation** (hereinafter "Assignee"),  
of (Assignee address) No.157, Shan-Ying Road, <sup>Gueishan</sup> ~~Kweishan~~, <sup>Tao-Yuan Hsien</sup> ~~Taoyuan~~, Taiwan, R.O.C.  
and the successors assigns and legal representatives of the ASSIGNEE the entire right, title,  
and interest in and to any and all improvements which are disclosed in the invention  
entitled: " ~~FLUID INJECTION HEAD STRUCTURE AND METHOD FOR~~  
~~MANUFACTURING THE SAME~~ "

*METHOD FOR FABRICATING A FLUID INJECTION  
HEAD STRUCTURE*

Which is found in :

- (a) \_\_\_\_\_ U.S. patent application executed on even date herewith  
(b) \_\_\_\_\_ U.S. patent application executed on \_\_\_\_\_  
(c) \_\_\_\_\_ U.S. application serial no. \_\_\_\_\_  
(d) \_\_\_\_\_ patent no. \_\_\_\_\_ issued \_\_\_\_\_

and, in and to, all Letters Patent to be obtained for said invention by the above application or ant continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this 10/09/02 (Date of signing).

(Type name of inventor)

Signature of INVENTOR

Tsung-Wei Huang

Tsung-Wei Huang

Chih-Ching Chen

Chih-Ching Chen

\_\_\_\_\_

\_\_\_\_\_

\_\_\_\_\_

\_\_\_\_\_

\_\_\_\_\_

\_\_\_\_\_